

100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C (Note 10)
100V	8.8mΩ @ V _{GS} = 10V	100A
1000	11.5mΩ @ V _{GS} = 6V	100A

Description

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP.

Applications

- Motor Control
- DC-DC Converters
- Power Management

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Minimizes On-State Losses
- · Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

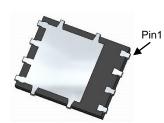
Mechanical Data

- Case: PowerDI[®] 5060-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)

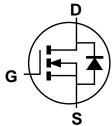
PowerDI5060-8



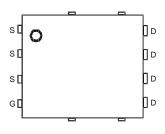
Top View



Bottom View



Internal Schematic



Top View Pin Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH10H010SPSQ-13	PowerDI5060-8	2,500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



☐ ☐ H= Manufacturer's Marking
TH10H010S = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 18 = 2018)
WW = Week Code (01 to 53)



Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V_{DSS}	100	V	
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	$T_A = +25$ °C $T_A = +100$ °C	I _D	11.8 8.3	А
Continuous Drain Current, $V_{GS} = 10V$ (Note 7) $T_C = +25^{\circ}C$ (Note 10) $T_C = +100^{\circ}C$		Ι _D	100 87	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	250	Α	
Maximum Continuous Body Diode Forward Current	Is	100	Α	
Avalanche Current, L = 0.3mH	I _{AS}	25	Α	
Avalanche Energy, L = 0.3mH	Eas	93.7	mJ	
Avalanche Current (Note 8), L = 3mH	I _{AS}	14.3	Α	
Avalanche Energy (Note 8), L = 3mH	E _{AS}	307	mJ	

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	P_{D}	1.5	W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	99	°C/W	
Total Power Dissipation (Note 7) $T_C = +25^{\circ}C$		P_{D}	166	W
Thermal Resistance, Junction to Case (Note 7)		R _{0JC}	0.9	°C/W
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +175	°C

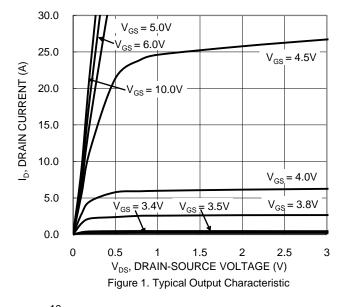
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

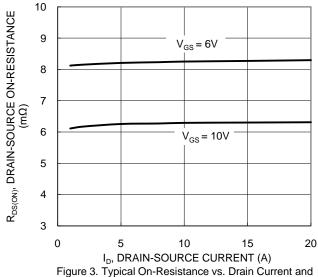
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	1	1	٧	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	2	-	4	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	6.6	8.8	mΩ	$V_{GS} = 10V, I_D = 13A$	
Static Diani-Source On-Resistance	R _{DS(ON)}	_	8.5	11.5	mt2	$V_{GS} = 6V, I_D = 13A$	
Diode Forward Voltage	V_{SD}	_	0.8	1.3	V	$V_{GS} = 0V, I_{S} = 13A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	_	4468	1		$V_{DS} = 50V$, $V_{GS} = 0V$ f = 1MHz	
Output Capacitance	Coss	_	746	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	32	_			
Gate Resistance	R_g	_	0.91	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Q_g	_	56.4	_		V 50V L 40A	
Gate-Source Charge	Q _{gs}	_	15.4	_	nC	$V_{DD} = 50V, I_D = 13A,$	
Gate-Drain Charge	Q _{gd}	_	14	_		$V_{GS} = 10V$	
Turn-On Delay Time	t _{D(ON)}	_	18.6	_			
Turn-On Rise Time	t _R	_	22.5	_		$V_{DD} = 50V, V_{GS} = 10V,$ $I_{D} = 13A, R_{g} = 6\Omega$	
Turn-Off Delay Time	t _{D(OFF)}	_	44.8	_	ns		
Turn-Off Fall Time	t _F	_	29.5	_		-	
Reverse Recovery Time	t _{RR}	_	54.5	_	ns	I 12A_di/dt _ 100A/up	
Reverse Recovery Charge	Q_{RR}	_	106.4	_	nC	I _F = 13A, di/dt = 100A/μs	

- 6. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
 8. Short duration pulse test used to minimize self-heating effect.
- Guaranteed by design. Not subject to product testing
 Package limited.









Gate Voltage

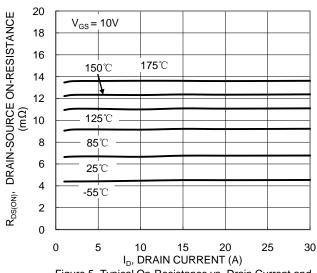
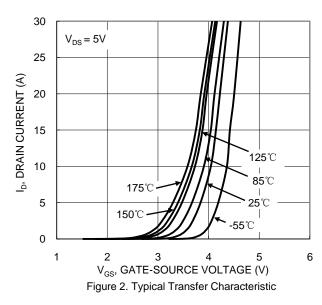
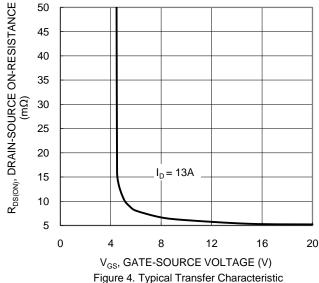


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





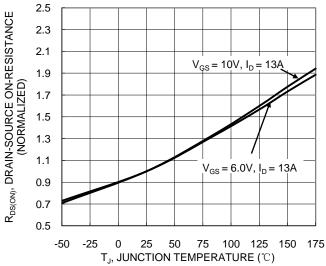


Figure 6. On-Resistance Variation with Junction Temperature





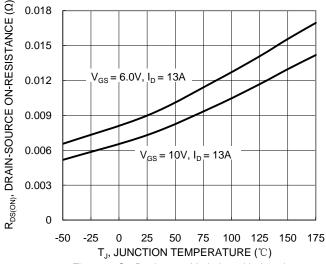
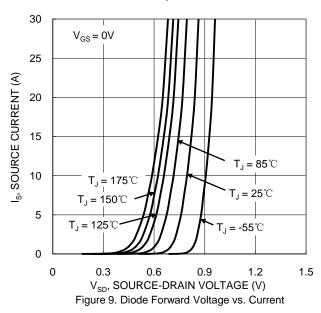
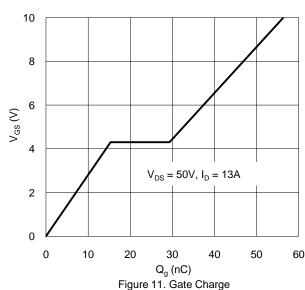


Figure 7. On-Resistance Variation with Junction Temperature





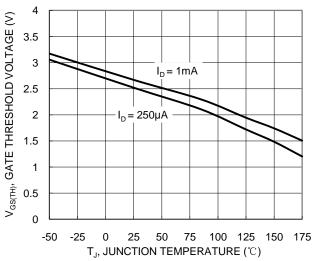
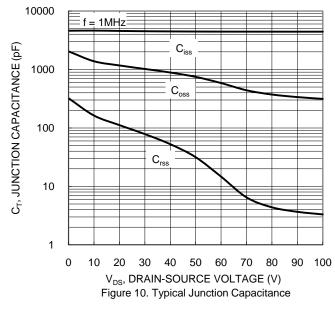
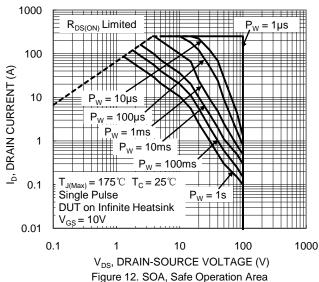


Figure 8. Gate Threshold Variation vs. Junction Temperature







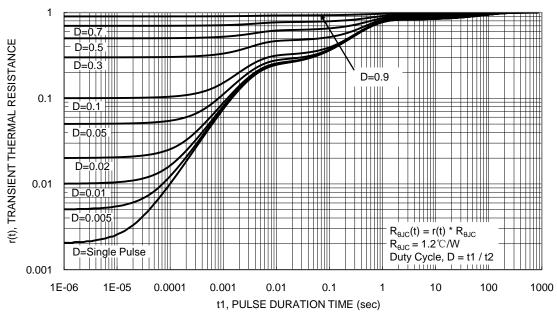


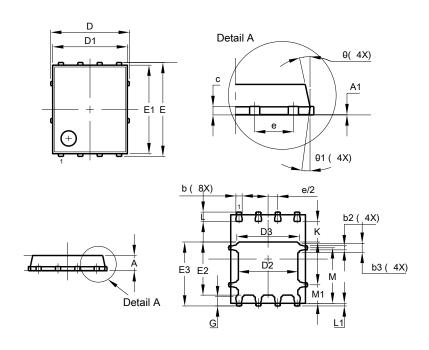
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8

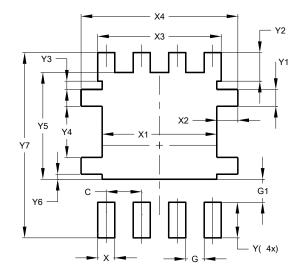


PowerDI5060-8						
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0.00	0.05	_			
b	0.33	0.51	0.41			
b2	0.200	0.350	0.273			
b3	0.40	0.80	0.60			
C	0.230	0.330	0.277			
D		5.15 BSC	;			
D1	4.70	5.10	4.90			
D2	3.70	4.10	3.90			
D3	3.90 4.30 4.10		4.10			
Е	(6.15 BSC				
E1	5.60	6.00	5.80			
E2	3.28	3.68	3.48			
E3	3.99	4.39	4.19			
е	1.27 BSC					
G	0.51	0.71	0.61			
K	0.51	-	-			
L	0.51	0.71	0.61			
L1	0.100	0.200	0.175			
M	3.235	4.035	3.635			
M1	1.00	1.40	1.21			
Θ	10°	12°	11°			
Θ1	6°	8°	7°			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8



Dimensions	Value (in mm)	
С	1.270	
G	0.660	
G1	0.820	
X	0.610	
X1	4.100	
X2	0.755	
Х3	4.420	
X4	5.610	
Y	1.270	
Y1	0.600	
Y2	1.020	
Y3	0.295	
Y4	1.825	
Y5	3.810	
Y6	0.180	
Y7	6.610	



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